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74F283 4-Bit Binary Full Adder with Fast Carry

General Description

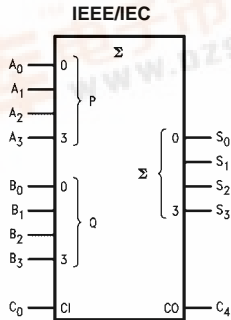
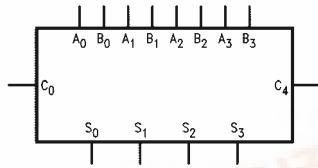
The 74F283 high-speed 4-bit binary full adder with internal carry lookahead accepts two 4-bit binary words (A_0 – A_3 , B_0 – B_3) and a Carry input (C_0). It generates the binary Sum outputs (S_0 – S_3) and the Carry output (C_4) from the most significant bit. The 74F283 will operate with either active HIGH or active LOW operands (positive or negative logic).

Ordering Code:

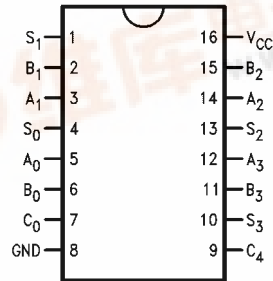
Order Number	Package Number	Package Description
74F283SC	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
74F283SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F283PC	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbols



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	U.L.	
		HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
A_0 – A_3	A Operand Inputs	1.0/2.0	20 μ A/–1.2 mA
B_0 – B_3	B Operand Inputs	1.0/2.0	20 μ A/–1.2 mA
C_0	Carry Input	1.0/1.0	20 μ A/–0.6 mA
S_0 – S_3	Sum Outputs	50/33.3	–1 mA/20 mA
C_4	Carry Output	50/33.3	–1 mA/20 mA

74F283 4-Bit Binary Full Adder with Fast Carry



Functional Description

The 74F283 adds two 4-bit binary words (A plus B) plus the incoming Carry (C_0). The binary sum appears on the Sum (S_0-S_3) and outgoing carry (C_4) outputs. The binary weight of the various inputs and outputs is indicated by the subscript numbers, representing powers of two.

$$2^0 (A_0 + B_0 + C_0) + 2^1 (A_1 + B_1) + 2^2 (A_2 + B_2) + 2^3 (A_3 + B_3) = S_0 + 2S_1 + 4S_2 + 8S_3 + 16C_4$$

Where (+) = plus

Interchanging inputs of equal weight does not affect the operation. Thus C_0 , A_0 , B_0 can be arbitrarily assigned to pins 5, 6 and 7 for DIPs, and 7, 8 and 9 for chip carrier packages. Due to the symmetry of the binary add function, the 74F283 can be used either with all inputs and outputs active HIGH (positive logic) or with all inputs and outputs active LOW (negative logic). See Figure 1. Note that if C_0 is not used it must be tied LOW for active HIGH logic or tied HIGH for active LOW logic.

Due to pin limitations, the intermediate carries of the 74F283 are not brought out for use as inputs or outputs.

However, other means can be used to effectively insert a carry into, or bring a carry out from, an intermediate stage. Figure 2 shows how to make a 3-bit adder. Tying the operand inputs of the fourth adder (A_3 , B_3) LOW makes S_3 dependent only on, and equal to, the carry from the third adder. Using somewhat the same principle, Figure 3 shows a way of dividing the 74F283 into a 2-bit and a 1-bit adder. The third stage adder (A_2 , B_2 , S_2) is used merely as a means of getting a carry (C_{10}) signal into the fourth stage (via A_2 and B_2) and bringing out the carry from the second stage on S_2 . Note that as long as A_2 and B_2 are the same, whether HIGH or LOW, they do not influence S_2 . Similarly, when A_2 and B_2 are the same the carry into the third stage does not influence the carry out of the third stage. Figure 4 shows a method of implementing a 5-input encoder, where the inputs are equally weighted. The outputs S_0 , S_1 and S_2 present a binary number equal to the number of inputs I_1-I_5 that are true. Figure 5 shows one method of implementing a 5-input majority gate. When three or more of the inputs I_1-I_5 are true, the output M_5 is true.

	C_0	A_0	A_1	A_2	A_3	B_0	B_1	B_2	B_3	S_0	S_1	S_2	S_3	C_4
Logic Levels	L	L	H	L	H	H	L	L	H	H	H	L	L	H
Active HIGH	0	0	1	0	1	1	0	0	1	1	1	0	0	1
Active LOW	1	1	0	1	0	0	1	1	0	0	0	1	1	0

Active HIGH: $0 + 10 + 9 = 3 + 16$ Active LOW: $1 + 5 + 6 = 12 + 0$

FIGURE 1. Active HIGH versus Active LOW Interpretation

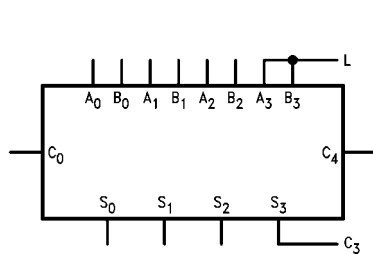


FIGURE 2. 3-Bit Adder

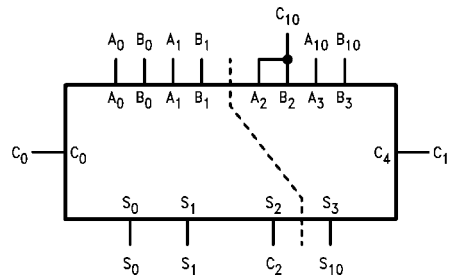


FIGURE 3. 2-Bit and 1-Bit Adders

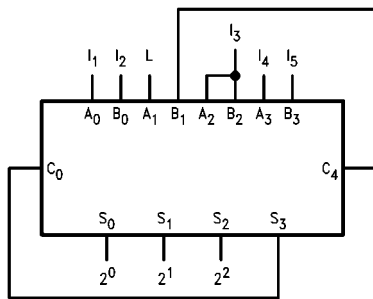


FIGURE 4. 5-Input Encoder

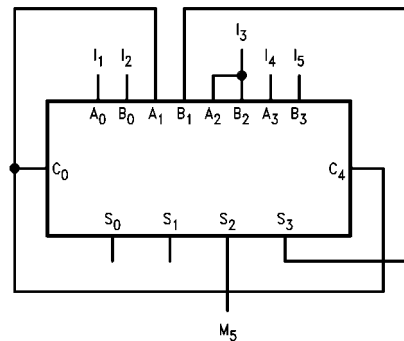
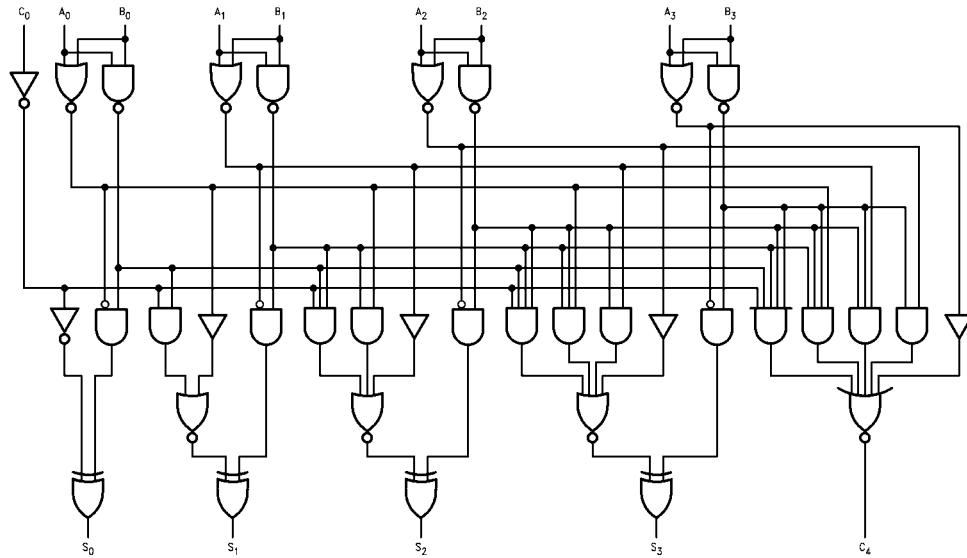


FIGURE 5. 5-Input Majority Gate

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 1)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V _{CC} = 0V)	
Standard Output	-0.5V to V _{CC}
3-STATE Output	-0.5V to +5.5V
Current Applied to Output in LOW State (Max)	twice the rated I _{OL} (mA)
ESD Last Passing Voltage (Min)	4000V

Recommended Operating Conditions

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

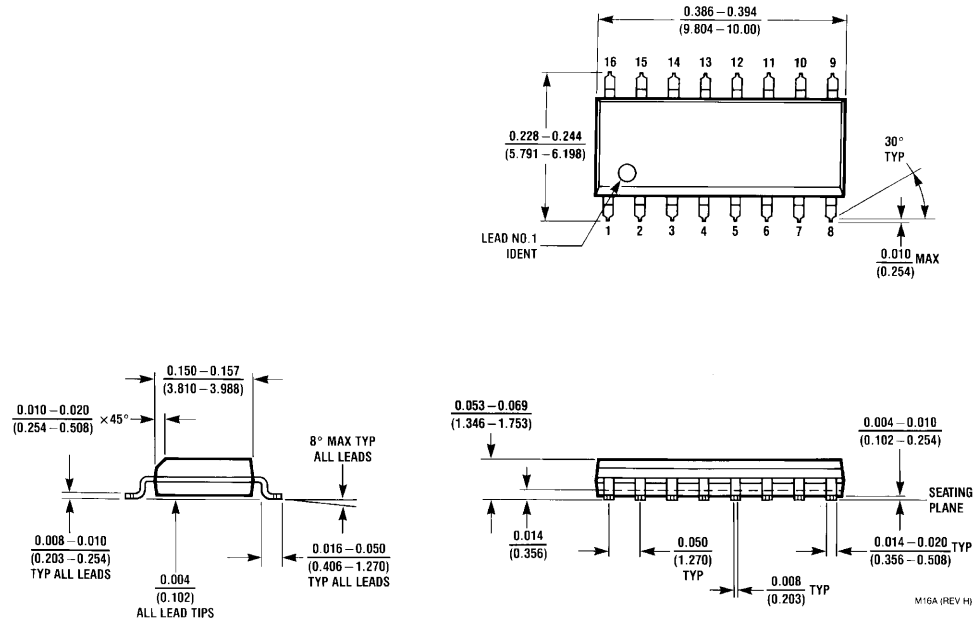
DC Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Units	V _{CC}	Conditions
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	10% V _{CC}	2.5		V	Min	I _{OH} = -1 mA
		5% V _{CC}	2.7				I _{OH} = -1 mA
V _{OL}	Output LOW Voltage	10% V _{CC}		0.5	V	Min	I _{OL} = 20 mA
I _{IH}	Input HIGH Current			5.0	μA	Max	V _{IN} = 2.7V
I _{BVI}	Input HIGH Current Breakdown Test			7.0	μA	Max	V _{IN} = 7.0V
I _{CEX}	Output HIGH Leakage Current			50	μA	Max	V _{OUT} = V _{CC}
V _{ID}	Input Leakage Test	4.75			V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current			3.75	μA	0.0	V _{IOD} = 150 mV All Other Pins Grounded
I _{IL}	Input LOW Current			-0.6	mA	Max	V _{IN} = 0.5V (C ₀)
				-1.2			V _{IN} = 0.5V (A _n , B _n)
I _{OS}	Output Short-Circuit Current	-60		-150	mA	Max	V _{OUT} = 0V
I _{CCH}	Power Supply Current		36	55	mA	Max	V _O = HIGH
I _{CCL}	Power Supply Current		36	55	mA	Max	V _O = LOW

AC Electrical Characteristics

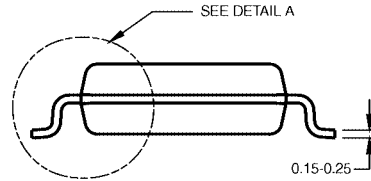
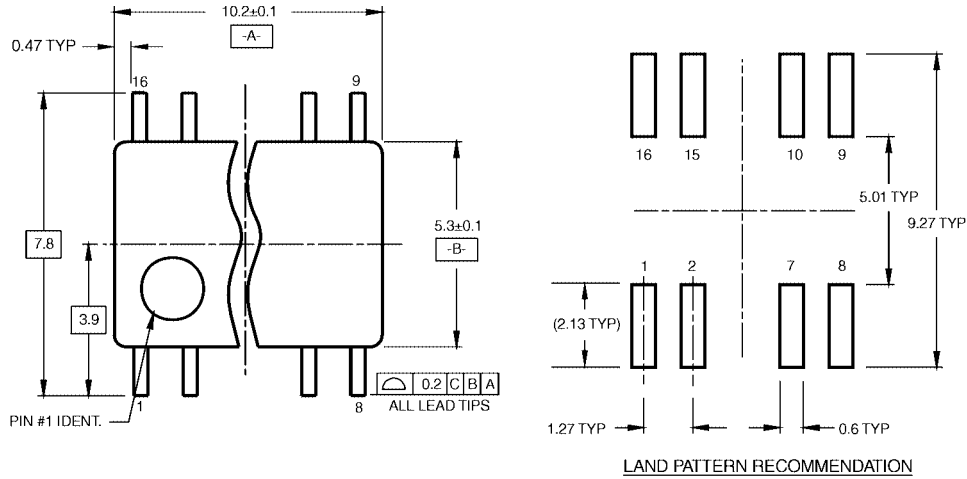
Symbol	Parameter	T _A = +25°C V _{CC} = +5.0V C _L = 50 pF			T _A = -55°C to +125°C V _{CC} = 5.0V C _L = 50 pF		T _A = 0°C to +70°C V _{CC} = 5.0V C _L = 50 pF		Units
		Min	Typ	Max	Min	Max	Min	Max	
		t _{PLH}	Propagation Delay C ₀ to S _n	3.5	7.0	9.5	3.5	14.0	
t _{PHL}		3.0	7.0	9.5	3.0	14.0	3.0	11.0	
t _{PLH}	Propagation Delay A _n or B _n to S _n	3.0	7.0	9.5	3.0	17.0	3.0	13.0	ns
t _{PHL}		3.0	7.0	9.5	3.0	14.0	3.0	11.5	
t _{PLH}	Propagation Delay C ₀ to C ₄	3.0	5.7	7.5	3.0	10.5	3.0	8.5	ns
t _{PHL}		3.0	5.4	7.0	2.5	10.0	3.0	8.0	
t _{PLH}	Propagation Delay A _n or B _n to C ₄	3.0	5.7	7.5	3.0	10.5	3.0	8.5	ns
t _{PHL}		2.5	5.3	7.0	2.5	10.0	2.5	8.0	

Physical Dimensions inches (millimeters) unless otherwise noted



**16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A**

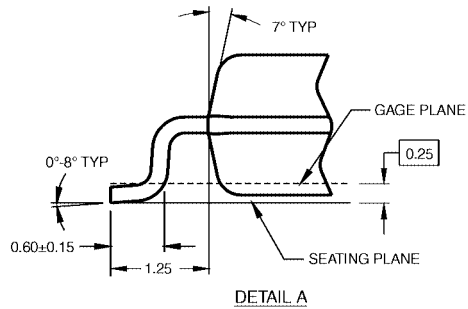
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS

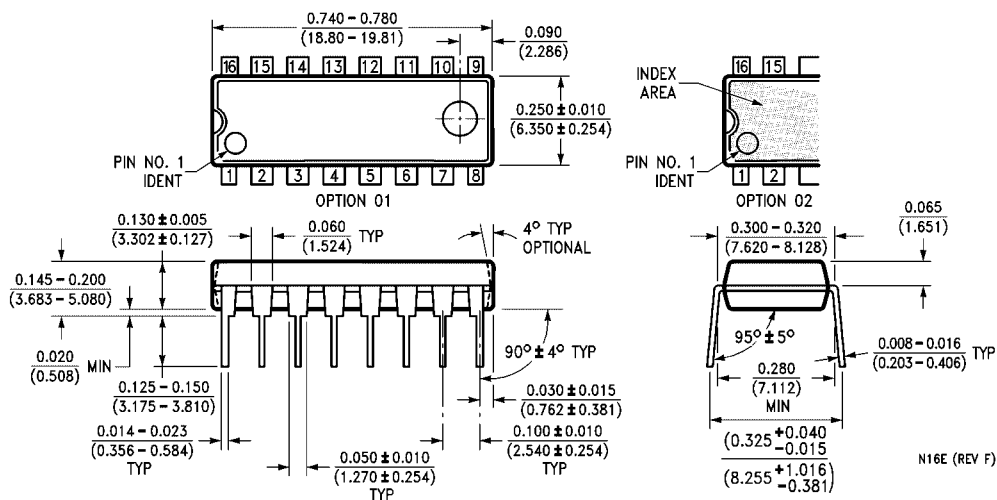
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 B. DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DRevB1



**16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
 Package Number M16D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N16E

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